

# **FDC6330L**

## **Integrated Load Switch**

### **General Description**

This device is particularly suited for compact power management in portable electronic equipment where 3V to 20V input and 2.3A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) which drives a large P-Channel power MOSFET (Q2) in one tiny SuperSOT<sup>TM</sup>-6 package.

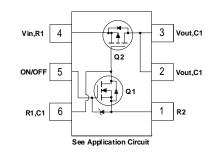
### **Applications**

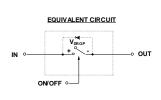
- Power management
- Load actuation

### **Features**

- $\begin{array}{l} \bullet \text{ V} \\ \text{V} \\ \text{DROP} \\ \text{DROP} \\ \end{array} = 0.2 \text{V} \text{ @ V} \\ \text{V} \\ \text{IN} \\ \end{array} = 12 \text{V}, \\ \text{I} \\ \text{L} \\ \text{E} \\ \text{1.6 A. R} \\ \text{R} \\ \text{(ON)} \\ \text{0.125 } \Omega. \end{array} = 0.08 \text{ } \Omega \\ \text{V} \\ \text{DROP} \\ \text{R} \\ \text{ON)} \\ \text{ON} \\ \text{ON)} \\ \text{ON)} \\ \text{ON)} \\ \text{ON} \\ \text{ON}$
- Control MOSFET (Q1) includes Zener protection for ESD ruggedness (>6kV Human Body Model).
- High performance PowerTrench<sup>TM</sup> technology for extremely low on-resistance.
- SuperSOT<sup>TM</sup>-6 package design using copper lead frame for superior thermal and electrical capabilities.







## SuperSOT<sup>™</sup>-6

Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>IN</sub>	Input Voltage Range	(Note 1)	3 - 20	V
V <sub>ON/OFF</sub>	On/Off Voltage Range		1.5 - 8	V
I <sub>D</sub>	Load Current - Continuous	(Note 2)	2.3	A
	- Pulsed		10	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1)	0.7	W
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Temperature Range		-55 to +150	°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human-Body-Model (100pf/1500 Ohm)		6	kV

### Thermal Characteristics

$R_{\theta^{JA}}$	Thermal Resistance, Junction-to-Ambient	(Note 2)	180	°C/W
$R_{\theta^{JC}}$	Thermal Resistance, Junction-to-Case	(Note 2)	60	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
_330 ( _ Denotes pin 1)	FDC6330L	7"	8mm	3000 units

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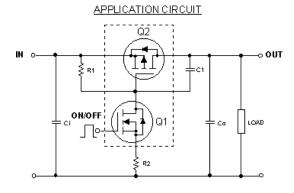
### Electrical Characteristics TA=25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
OFF Ch	aracteristics					
I <sub>FL</sub>	Leakage Current	$V_{IN} = 20 \text{ V}, V_{ON/OFF} = 250  \mu\text{A}$			1	μA
	aracteristics (Note 3)					
$V_{DROP}$	Conduction Voltage	$V_{IN} = 12 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}, I_L = 2.5 \text{ A}$			0.2	V
$V_{DROP}$	Conduction Voltage	$V_{IN} = 12 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}, I_L = 2.5 \text{ A}$ $V_{IN} = 5 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}, I_L = 1.6 \text{ A}$			0.2	V
	Conduction Voltage  Q2 - Static On-Resistance	, , , , , , , , , , , , , , , , , ,		0.054 0.081	_	
V <sub>DROP</sub> $R_{(ON)}$ $I_L$	, and the second	$V_{IN} = 5 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}, I_L = 1.6 \text{ A}$ $V_{GS} = -12 \text{ V}, I_D = -2.3 \text{ A}$	2.5		0.2	V

#### Notes

- 1. Range of  $V_{in}$  can be up to 30V, but  $R_1$  and  $R_2$  must be scaled such that  $V_{GS}$  of Q2 does not exceed 20V.
- 2.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2.0%.

### FDC6330L Load Switch Application



### **External Component Recommendation:**

For applications where  $Co \leq 1 \mu F.$ 

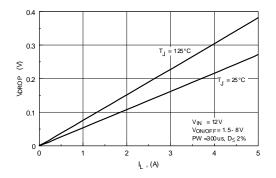
For slew rate control, select R2 in the range of 1k -  $4.7 k\Omega$  .

For additional in-rush current control,C1 ≤ 1000pF can be added.

Select R1 so that the R1/R2 ratio ranges from 10 - 100. R1 is required to turn Q2 off.

FDC6330L Rev. C

## Typical Characteristics (continued)



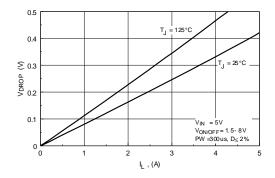


Figure 1. Conduction Voltage Drop Variation with Load Current.

Figure 2. Conduction Voltage Drop Variation with Load Current.

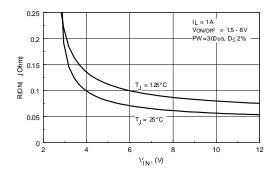
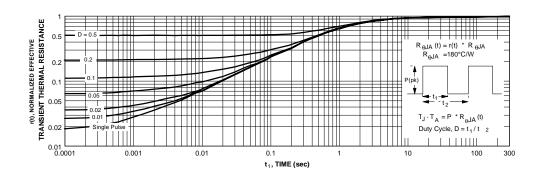


Figure 3. On-Resistance Variation with Input Voltage.



### Figure 4.Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 2. Transient themal response will change depending on the circuit board design.

FDC6330L Rev. C

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CROSSVOLT<sup>TM</sup> POP<sup>TM</sup>

E<sup>2</sup>CMOS<sup>™</sup> PowerTrench<sup>™</sup>

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